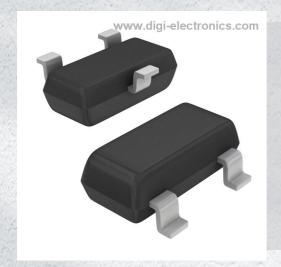


BC817-40LT3 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number BC817-40LT3-DG

Manufacturer onsemi

Manufacturer Product Number BC817-40LT3

Description TRANS NPN 45V 0.5A SOT23-3

Detailed Description Bipolar (BJT) Transistor NPN 45 V 500 mA 100MHz 3

00 mW Surface Mount SOT-23-3 (TO-236)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
BC817-40LT3	onsemi
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
NPN	500 mA
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
45 V	700mV @ 50mA, 500mA
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
100nA (ICBO)	250 @ 100mA, 1V
Power - Max:	Frequency - Transition:
300 mW	100MHz
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
TO-236-3, SC-59, SOT-23-3	SOT-23-3 (TO-236)
Base Product Number:	
BC817	

Environmental & Export classification

8541.21.0075

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

BC817-16LT1, BC817-25LT1, BC817-40LT1

General Purpose Transistors

NPN Silicon

Features

• Pb-Free Packages are Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V_{CEO}	45	V
Collector - Base Voltage	V_{CBO}	50	V
Emitter – Base Voltage	V_{EBO}	5.0	V
Collector Current - Continuous	Ic	500	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C Derate above 25°C	P _D	225 1.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C	P _D	300 2.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

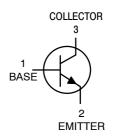
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. $FR-5 = 1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = 0.4 x 0.3 x 0.024 in 99.5% alumina.



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http://onsemi.com





SOT-23 CASE 318 STYLE 6

MARKING DIAGRAM



6x = Device Code

x = A, B, or C

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

BC817-16LT1, BC817-25LT1, BC817-40LT1

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS		•		•	•	•
Collector – Emitter Breakdown Voltage (I _C = 10 mA)		V _{(BR)CEO}	45	_	_	V
Collector – Emitter Breakdown Voltage ($V_{EB} = 0$, $I_C = 10 \mu A$)		V _(BR) CES	50	_	-	V
Emitter – Base Breakdown Voltage (I _E = 1.0 μA)		V _{(BR)EBO}	5.0	-	-	V
Collector Cutoff Current $(V_{CB} = 20 \text{ V})$ $(V_{CB} = 20 \text{ V}, T_A = 150^{\circ}\text{C})$		I _{CBO}	- -	_ _ _	100 5.0	nA μA
ON CHARACTERISTICS						
DC Current Gain $(I_C=100 \text{ mA}, \text{ V}_{CE}=1.0 \text{ V})$ $(I_C=500 \text{ mA}, \text{ V}_{CE}=1.0 \text{ V})$	BC817-16 BC817-25 BC817-40	h _{FE}	100 160 250 40	- - - -	250 400 600 –	-
Collector – Emitter Saturation Voltage (I _C = 500 mA, I _B = 50 mA)		V _{CE(sat)}	-	_	0.7	V
Base – Emitter On Voltage (I _C = 500 mA, V _{CE} = 1.0 V)		V _{BE(on)}	-	-	1.2	V
SMALL-SIGNAL CHARACTERISTICS						
Current – Gain – Bandwidth Product (I _C = 10 mA, V _{CE} = 5.0 Vdc, f = 100 MHz)		f _T	100	_	_	MHz
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)		C _{obo}	-	10	-	pF

ORDERING INFORMATION

Device	Specific Marking	Package	Shipping [†]		
BC817-16LT1G	64	SOT-23 (Pb-Free)	3000/Tape & Reel		
BC817-16LT3G	6A	SOT-23 (Pb-Free)	10,000/Tape & Reel		
BC817-25LT1		SOT-23	3000/Tape & Reel		
BC817-25LT1G	6B	SOT-23 (Pb-Free)	3000/Tape & Reel		
BC817-25LT3G		SOT-23 (Pb-Free)	10,000/Tape & Reel		
BC817-40LT1		SOT-23	3000/Tape & Reel		
BC817-40LT1G	6C	SOT-23 (Pb-Free)	3000/Tape & Reel		
BC817-40LT3G		SOT-23 (Pb-Free)	10,000/Tape & Reel		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

BC817-16LT1, BC817-25LT1, BC817-40LT1

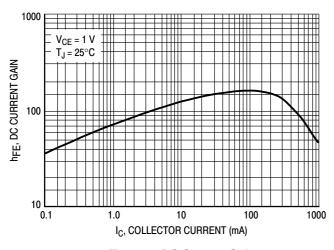


Figure 1. DC Current Gain

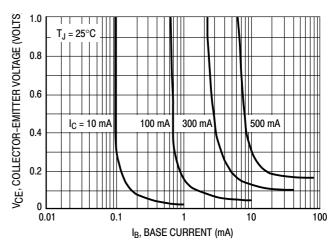


Figure 2. Saturation Region

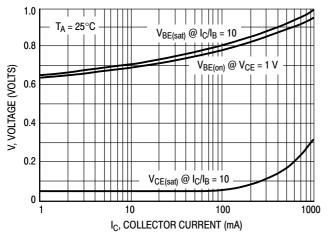


Figure 3. "On" Voltages

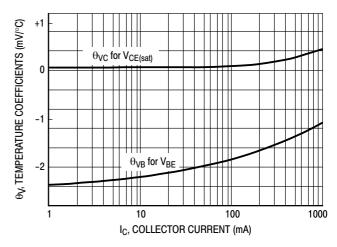


Figure 4. Temperature Coefficients

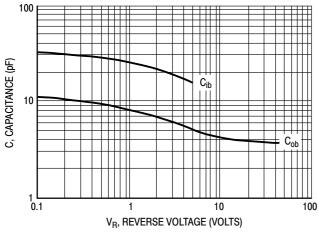


Figure 5. Capacitances

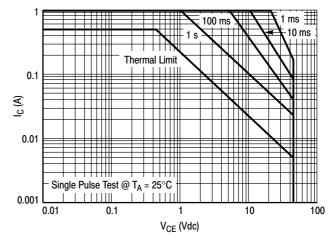
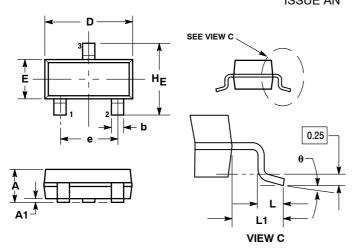


Figure 6. BC817-40L Safe Operating Area

BC817-16LT1, BC817-25LT1, BC817-40LT1

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**



NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

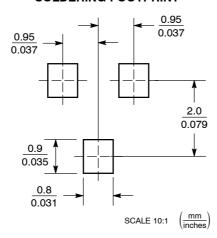
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 6:

PIN 1. BASE

- 2. **EMITTER**
- COLLECTOR

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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